High Power Infrared Emitting Diode, 850 nm, Surface Emitter Technology

FEATURES

- Package type: surface-mount
- Package form: high power SMD with lens
- Dimensions (L x W x H in mm): 3.4 x 3.4 x 2.45
- Centroid wavelength: $\lambda_{centroid}$ = 850 nm
- Angle of half intensity: $\varphi = \pm 40°$
- Designed for high drive currents: up to 1.5 A (DC) and up to 5 A (pulsed)
- Low thermal resistance: 6 K/W < R_{thJSP} < 9 K/W
- ESD: up to 5 kV (according to ANSI / ESDA / JEDEC® JS-001)
- Floor life: 168 h, MSL 3, according to J-STD-020E
- Lead (Pb)-free reflow soldering
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Pb-free
e3
RoHS COMPLIANT
HALOGEN FREE
GREEN (5-2008)

LINKS TO ADDITIONAL RESOURCES

3D Models

DESCRIPTION

As part of the SurfLight™ portfolio, the VSMA1085400 is an infrared, 850 nm emitting diode. It features a double stack emitter chip for highest radiant power. The 42 mil chip size allows 1.5 A DC operation and supports pulsed currents up to 5.0 A.

APPLICATIONS

- Driver and occupant monitoring
- Eye tracking
- Safety and security, CCTV

PRODUCT SUMMARY

COMPONENT	I_e (mW/sr) at I_F = 1.0 A	φ (°)	λ_p (nm)	$\lambda_{centroid}$ (nm)	t_r (ns)
VSMA1085400	925	± 40	860	850	10

Note

- Test conditions see table “Basic Characteristics”

ORDERING INFORMATION

ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
VSMA1085400	Tape and reel	MOQ: 600 pcs, 600 pcs/reel	High power with lens

Note

- MOQ: minimum order quantity

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ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)				
PARAMETER	**TEST CONDITION**	**SYMBOL**	**VALUE**	**UNIT**
Reverse voltage		V_R	5	V
Forward current		I_F	1.5	A
Surge forward current	t_p = 100 µs	I_{FSM}	5	A
Power dissipation		P_V	5.33	W
Junction temperature		T_j	145	°C
Ambient temperature range		T_{amb}	-40 to +125	°C
Storage temperature range		T_{stg}	-40 to +125	°C
Soldering temperature	According to Fig. 11, J-STD-020E	T_{sd}	260	°C
Thermal resistance junction to solder point real [(1)]	JESD 51	$R_{thJSP,real}$	6 to 9	K/W
Thermal resistance junction to ambient real	JESD 51	$R_{thJA,real}$	150	K/W
ESD sensitivity	According to ANSI / ESDA / JEDEC JS-001	V_{ESD}	5	kV

Note

(1) Thermal resistance junction to solder point real has been measured with the part mounted on an ideal heatsink and the optical output power has been deducted from the total electrical power dissipation

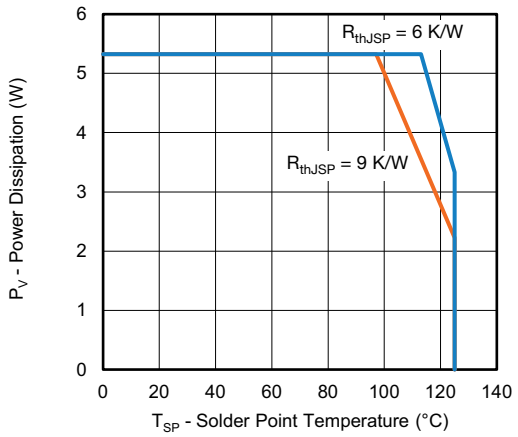

Fig. 1 - Power Dissipation Limit vs. Solder Point Temperature

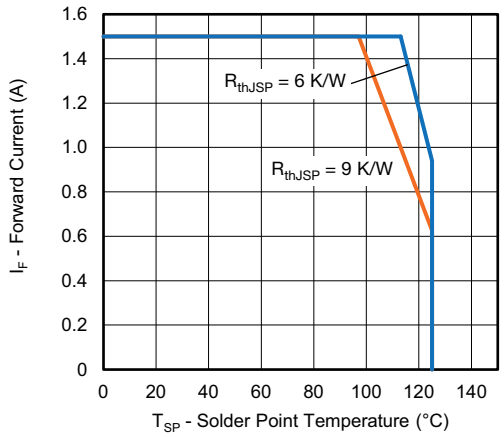

Fig. 2 - Forward Current Limit vs. Solder Point Temperature

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BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Forward voltage	I_F = 0.35 A, t_p = 10 ms	V_F	2.7	2.95	3.1	V
	I_F = 1 A, t_p = 100 µs	V_F	2.8	3.1	3.3	V
	I_F = 1.5 A, t_p = 100 µs	V_F	2.9	3.25	3.55	V
	I_F = 5 A, t_p = 100 µs	V_F	3.2	3.9	4.4	V
Temperature coefficient of V_F	I_F = 1 A, t_p = 200 µs		-	-2	-	mV/K
Reverse current		I_R	Not designed for reverse operation			µA
Radiant intensity	I_F = 0.35 A, t_p = 10 ms	I_e	275	350	425	mW/sr
	I_F = 1 A, t_p = 100 µs	I_e	700	925	1150	mW/sr
	I_F = 1.5 A, t_p = 100 µs	I_e	975	1350	1725	mW/sr
	I_F = 5 A, t_p = 100 µs	I_e	2850	4100	5350	mW/sr
Radiant power	I_F = 1 A, t_p = 100 µs	ϕ_e	-	1425	-	mW
	I_F = 1.5 A, t_p = 100 µs	ϕ_e	-	2100	-	mW
Temperature coefficient of ϕ	I_F = 1 A, t_p = 200 µs	TK_ϕ	-	-0.15	-	%/K
Angle of half intensity		φ	-	± 40	-	°
Peak wavelength	I_F = 1 A, t_p = 300 µs	λ_p	-	860	-	nm
Centroid wavelength	I_F = 1 A, t_p = 300 µs	$\lambda_{centroid}$	-	850	-	nm
Spectral bandwidth	I_F = 1 A, t_p = 300 µs	$\Delta\lambda$	-	30	-	nm
Temperature coefficient of λ_p	I_F = 100 mA, t_p = 20 ms	$TK_{\lambda p}$	-	0.25	-	nm/K
Rise time	I_F = 1 A	t_r	-	10	-	ns
Fall time	I_F = 1 A	t_f	-	15	-	ns

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

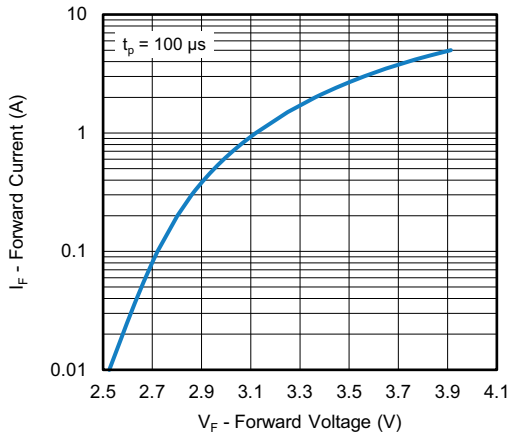

Fig. 3 - Forward Current vs. Forward Voltage

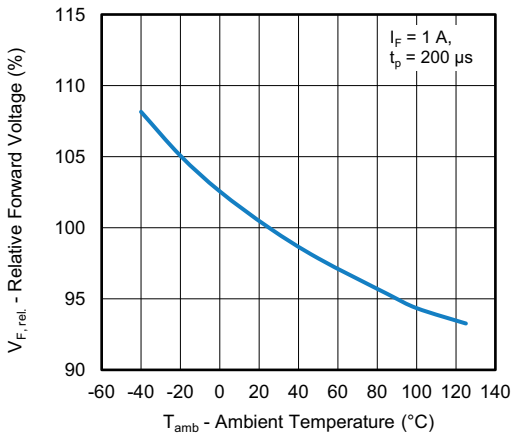

Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

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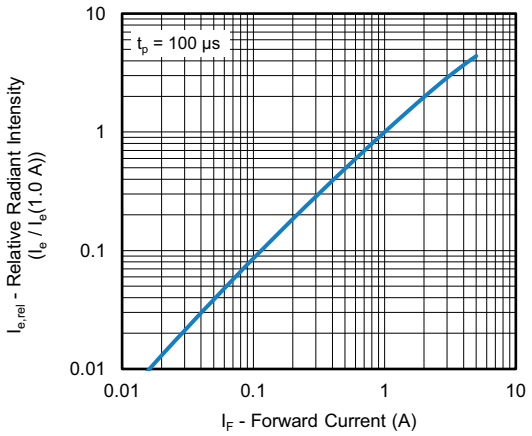

Fig. 5 - Relative Radiant Intensity vs. Forward Current

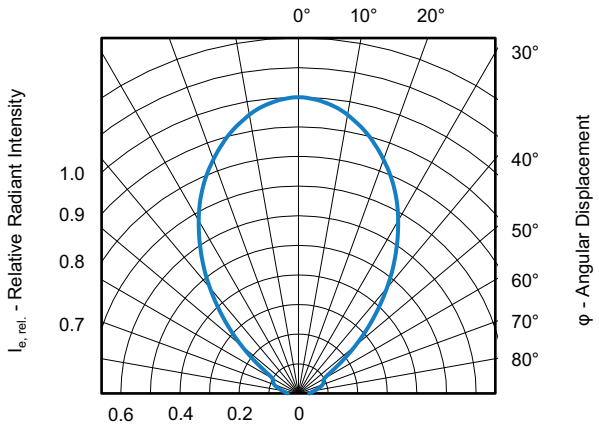

Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

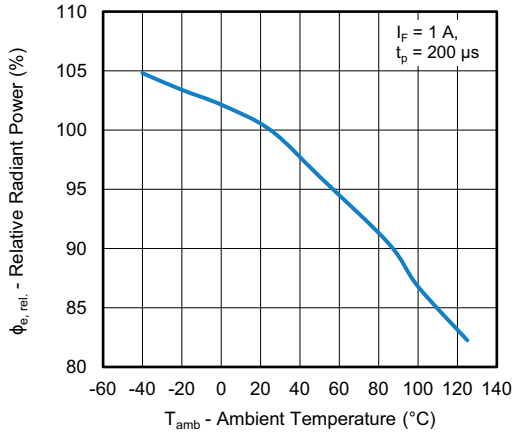

Fig. 6 - Relative Radiant Power vs. Ambient Temperature

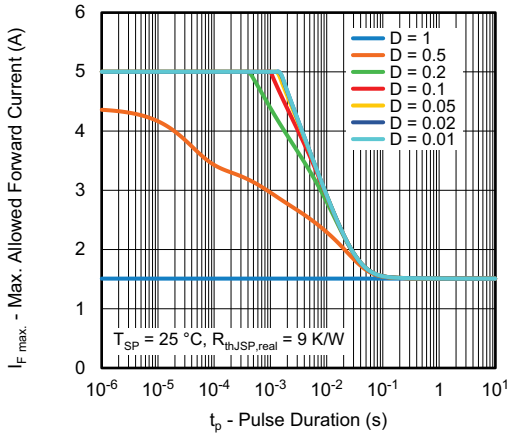

Fig. 9 - Max. Allowed Forward Current vs. Pulse Duration

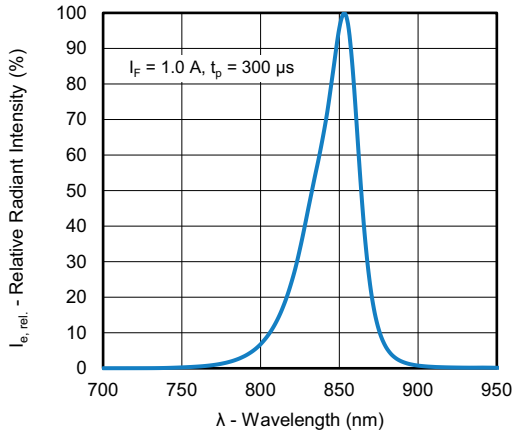

Fig. 7 - Relative Radiant Intensity vs. Wavelength

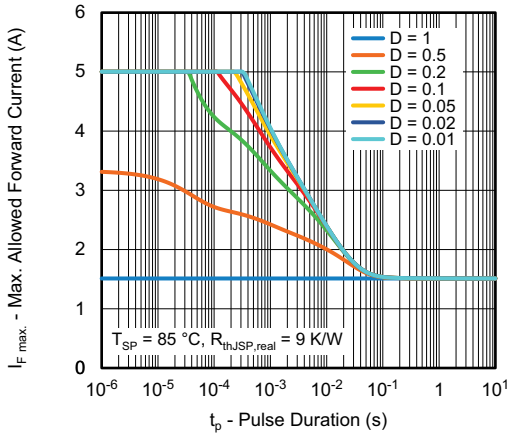

Fig. 10 - Max. Allowed Forward Current vs. Pulse Duration

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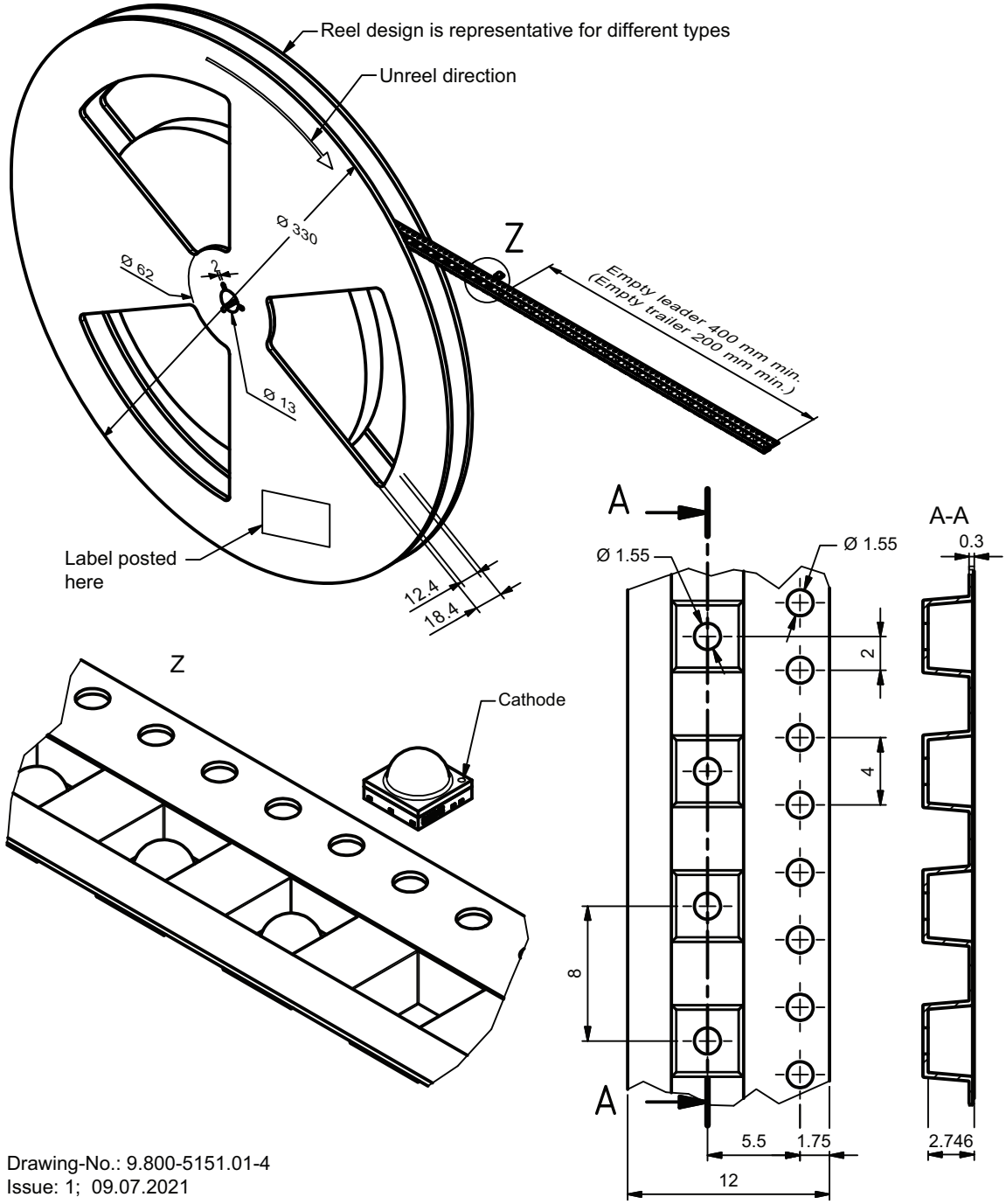
TAPING DIMENSIONS in millimeters



Drawing-No.: 9.800-5151.01-4
Issue: 1; 09.07.2021

Notes

- Empty component pockets sealed with top cover tape
- 7 inch reel - 600 pieces per reel
- The maximum number of consecutive missing lamps is two
- In accordance with ANSI / EIA 481-1-A-1994 specifications

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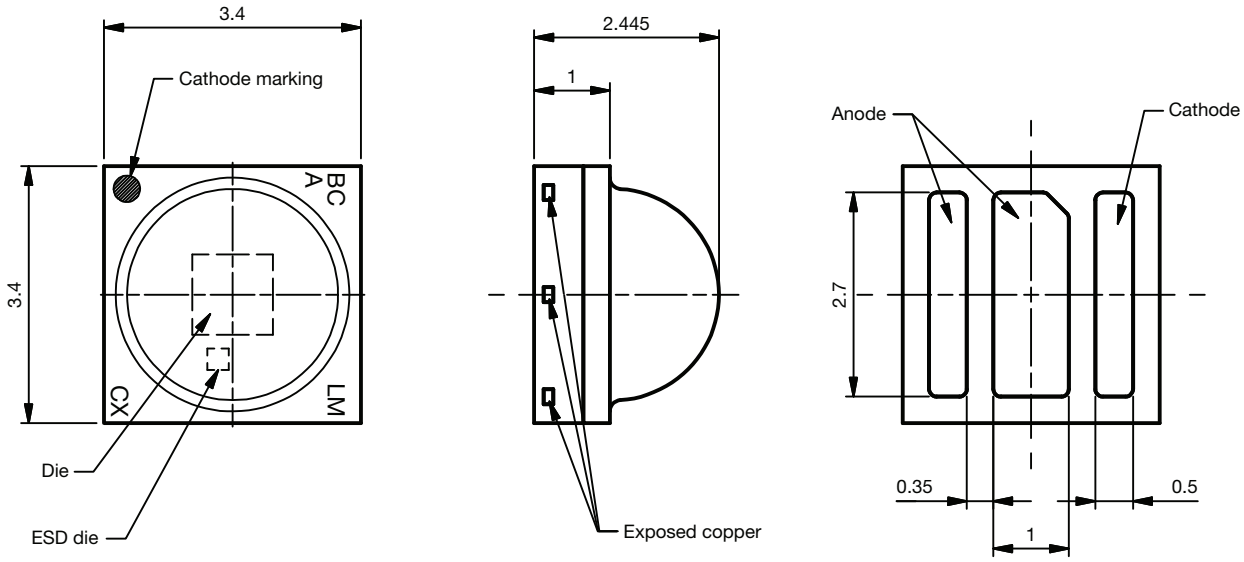
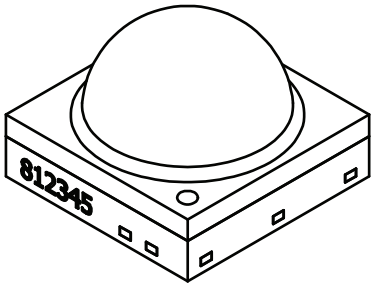
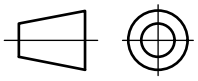
PACKAGE DIMENSIONS in millimeters



Not indicated tolerances ± 0.1





Technical drawings according to DIN specification

Drawing-No.: 6.550-5367.01-4
Issue: 1; 09.07.2021

Notes

- Tolerance is ± 0.10 mm (0.004") unless otherwise noted
- Specifications are subject to change without notice

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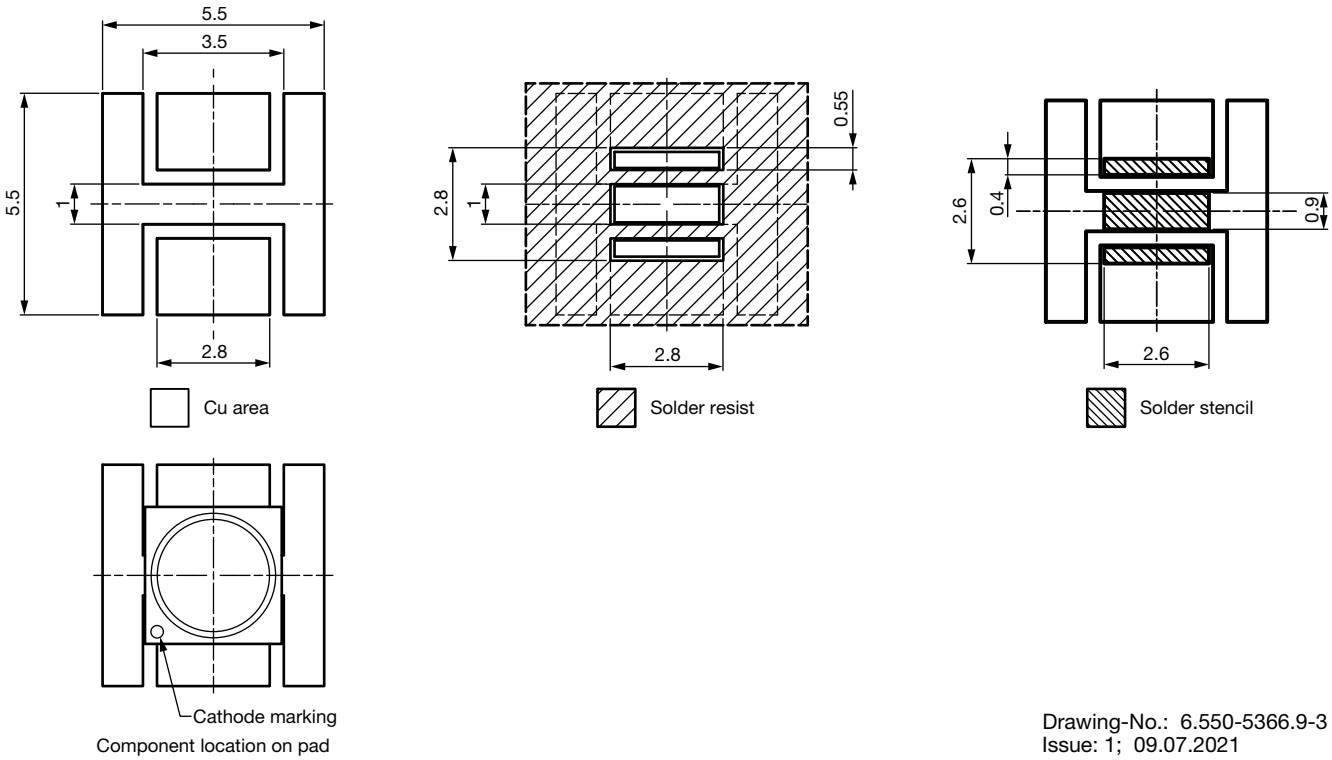
RECOMMENDED FOOTPRINT



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Issue: 1; 09.07.2021

SOLDER PROFILE

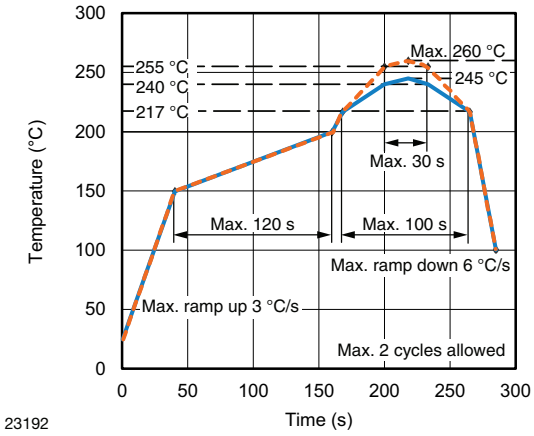

Fig. 11 - Lead (Pb)-free (Sn) Infrared Reflow Solder Profile According to J-STD-020E for Surface-Mount Components

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

FLOOR LIFE

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions: T_{amb} < 30 °C, RH < 60 %

Moisture sensitivity level 3, according to J-STD-020E

DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-033D or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.

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